

Applications

- Automotive
- Industrial
- Computer
- Consumer

Features

- Schmitt trigger action with no external components
- Hysteresis voltage typically:
0.9 V at $V_{DD} = 5\text{ V}$
2.3 V at $V_{DD} = 10\text{ V}$
3.5 V at $V_{DD} = 15\text{ V}$
- Noise immunity greater than 50%
- No limit on input rise and fall times
- Low V_{DD} to V_{SS} current during slow input ramp
- Standardized symmetrical output characteristics
- Quiescent current specified up to 20 V
- 5 V, 10 V, and 15 V parametric ratings
- Input leakage current $I_l = 100\text{ nA}$ (max.) at $V_{DD} = 18\text{ V}$ and $T_A = 25\text{ }^\circ\text{C}$
- 100% tested for quiescent current
- ESD performance
 - HBM: 2 kV
 - MM: 200 V
 - CDM: 1 kV

Description

The HCF40106 is a monolithic integrated circuit fabricated in metal oxide semiconductor technology available in an SO-14 package.

The HCF40106 consists of six Schmitt trigger circuits. Each circuit functions as an inverter with Schmitt trigger action on the input. The trigger switches at different points for positive and negative-going signals. The difference between the positive voltage (V_P) and the negative voltage (V_N) is defined as hysteresis voltage (V_H).

Table 1. Device summary table

Order code	Temperature range	Package	Packing	Marking
HCF40106M013TR	-55 ° C to +125 ° C	SO-14	Tape & reel	HCF40106
HCF40106YM013TR ⁽¹⁾	-40 ° C to +125 ° C	SO-14 (automotive grade) ⁽¹⁾		HCF40106Y

1. Qualification and characterization according to AEC Q100 and Q003 or equivalent, advanced screening according to AEC Q001 and Q002 or equivalent.

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1 Pin information

Figure 1. Pin connections (top view)

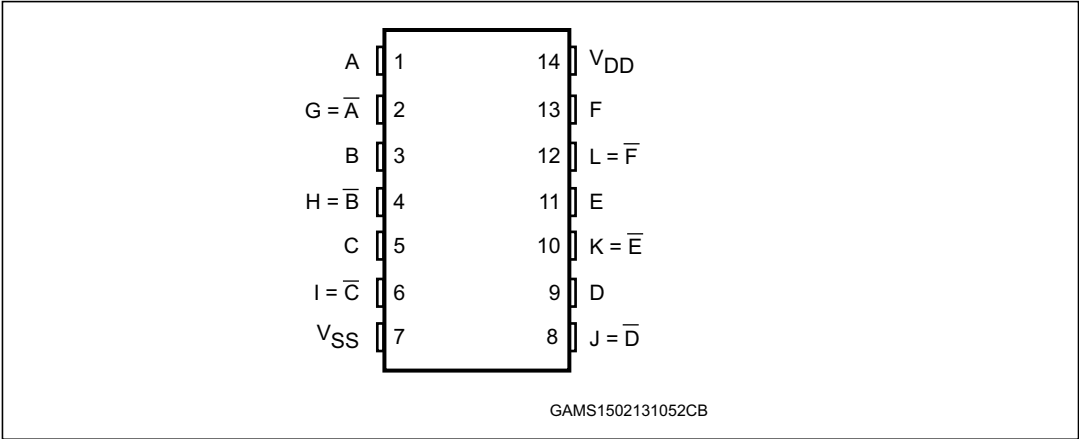
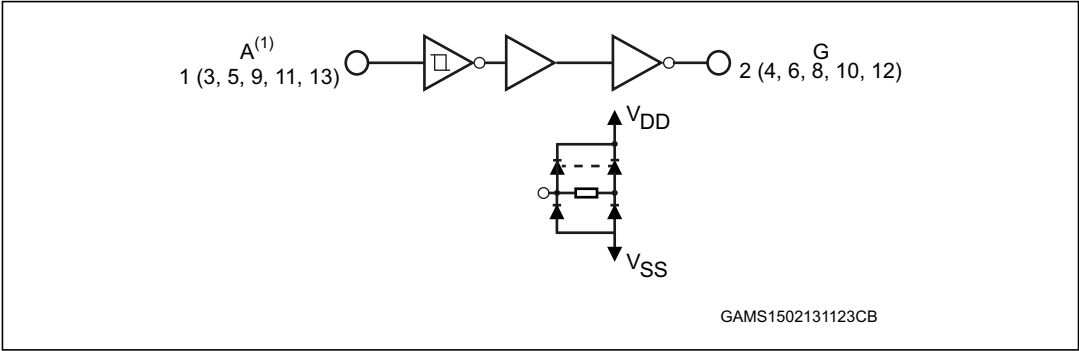


Table 2. Pin description

Pin no	Symbol	Name and function
1, 3, 5, 9, 11, 13	A, B, C, D, E, F	Data inputs
2, 4, 6, 8, 10, 12	G, H, I, J, K, L	Data outputs
7	V _{SS}	Negative supply voltage
14	V _{DD}	Positive supply voltage

2 Functional description

Figure 2. Logic diagram



1. All inputs protected by COS/MOS protection network.

Table 3. Truth table

Inputs (A to F)	Outputs (G to L)
L	H
H	L

Figure 3. Functional diagram

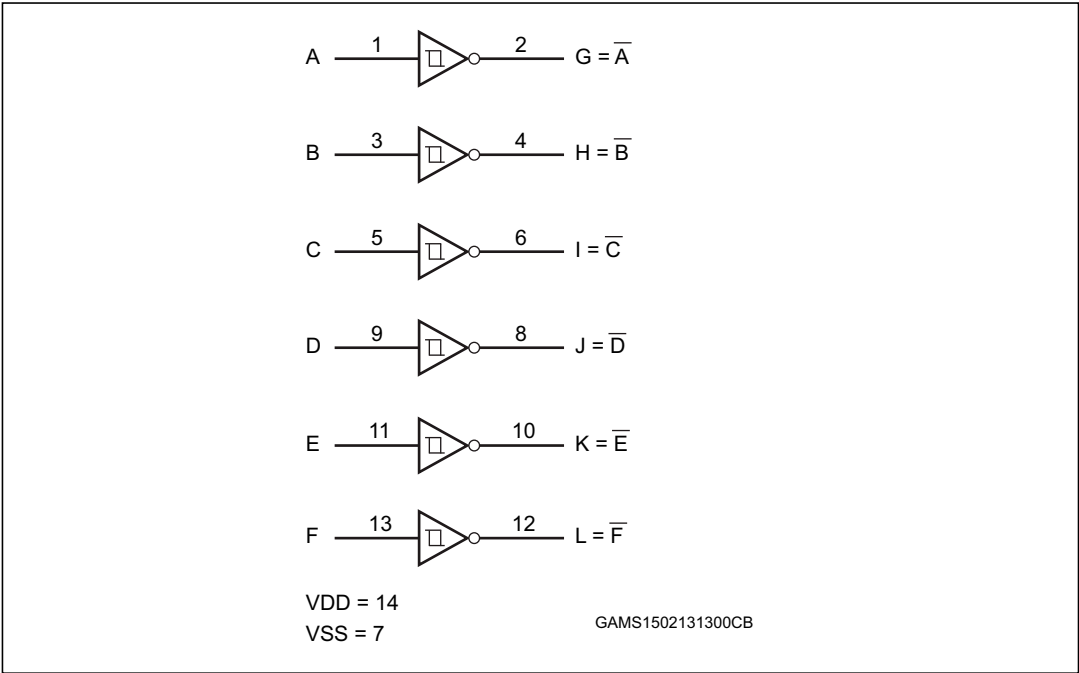
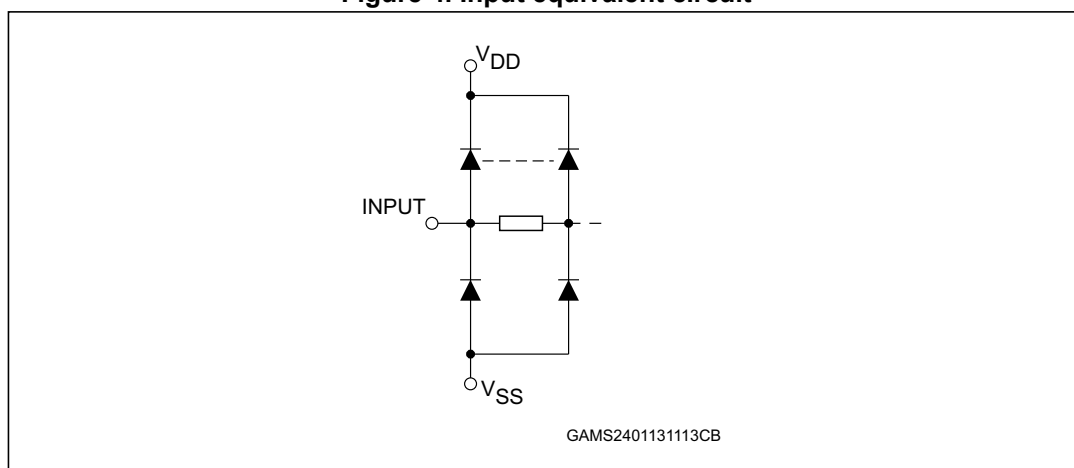


Figure 4. Input equivalent circuit



3 Electrical characteristics

Absolute maximum ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied. All voltage values are referred to V_{SS} pin voltage.

Table 4. Absolute maximum ratings (AMR)

Symbol	Parameter	Value	Unit
V_{DD}	Supply voltage	-0.5 to +22	V
V_I	DC input voltage	-0.5 to $V_{DD} + 0.5$	
I_I	DC input current	± 10	mA
P_D	Power dissipation per package	200	mW
	Power dissipation per output transistor	100	
T_{op}	Operating temperature	-55 to +125	°C
T_{stg}	Storage temperature	-65 to +150	

Table 5. Recommended operating conditions

Symbol	Parameter	Value	Unit
V_{DD}	Supply voltage	3 to 20	V
V_I	Input voltage	0 to V_{DD}	
T_{op}	Operating temperature	-55 to 125	°C

Table 6. DC specifications⁽¹⁾

Sym.	Parameter	Test condition				Value							Unit
		V _I (V)	V _O (V)	I _O (μA)	V _{DD} (V)	T _A = 25 °C			-40 to 85 °C		-55 to 125 °C		
						Min.	Typ.	Max.	Min.	Max.	Min.	Max.	
I _L	Quiescent current	0/5			5			1		30		30	μA
		0/10			10		0.02	2		60		60	
		0/15			15			4		120		120	
		0/20			20		0.04	20		600		600	
V _{OH}	High level output voltage	0/5	<1	5	4.95			4.95		4.95		V	
		0/10		10	9.95		9.95		9.95				
		0/15		15	14.95		14.95		14.95				
V _{OL}	Low level output voltage	5/0	<1	5							0.05		
		10/0		10		0.05		0.05					
		15/0		15									
V _P	Positive trigger threshold voltage			5	2.2	2.9	3.6	2.2	3.6	2.2	3.6		
				10	4.6	5.9	7.1	4.6	7.1	4.6	7.1		
				15	6.8	8.8	10.8	6.8	10.8	6.8	10.8		
V _N	Negative trigger threshold voltage			5	0.9	1.9	2.8	0.9	2.8	0.9	2.8		
				10	2.5	3.9	5.2	2.5	5.2	2.5	5.2		
				15	4	5.8	7.4	4	7.4	4	7.4		
V _H	Hysteresis voltage			5	0.3	0.9	1.6	0.3	1.6	0.3	1.6		
				10	1.2	2.3	3.4	1.2	3.4	1.2	3.4		
				15	1.6	3.5	5	1.6	5	1.6	5		
I _{OH}	Output drive current	0/5	2.5	5	-1.36	-3.2		-1.15		-1.1		mA	
			4.6			-0.44	-1		-0.36		-0.36		
		0/10	9.5	10	-1.1	-2.6		-0.9		-0.9			
		0/15	13.5	15	-3.0	-6.8		-2.4		-2.4			
I _{OL}	Output sink current	0/5	0.4	5	0.44	1		0.36		0.36		mA	
		0/10	0.5	10	1.1	2.6		0.9		0.9			
		0/15	1.5	15	3.0	6.8		2.4		2.4			
I _I	Input leakage current	0/18	Any input		18		±10 ⁻⁵	±0.1		±1		±1	μA
C _I	Input capacitance		Any input				5	7.5					pF

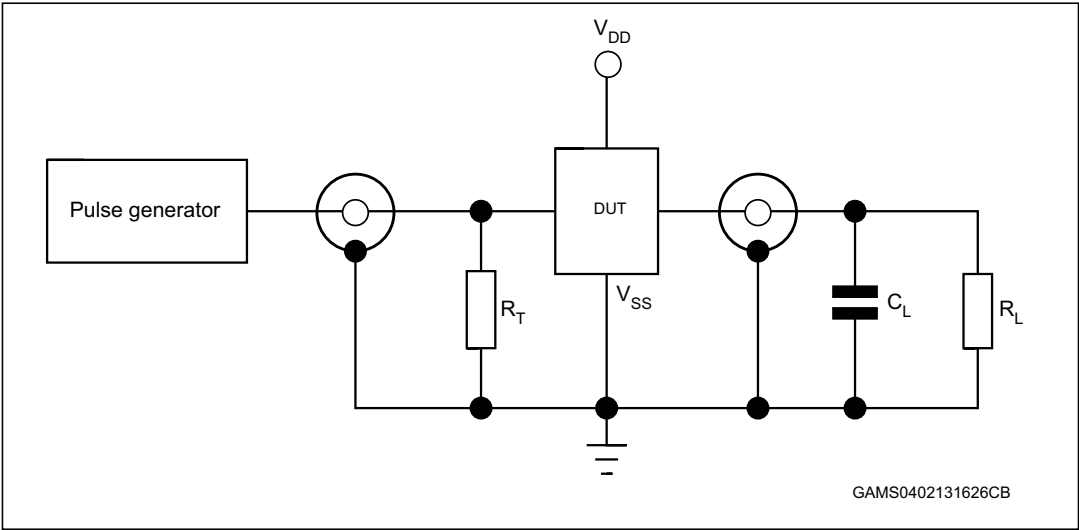
1. The noise margin for both level "1" and "0" is: 1 V min. with V_{DD} = 5 V, 2 V min. with V_{DD} = 10 V, and 2.5 V min. with V_{DD} = 15 V.

Table 7. Dynamic electrical characteristics
 ($T_{amb} = 25\text{ }^{\circ}\text{C}$, $C_L = 50\text{ pF}$, $R_L = 200\text{ k}\Omega$, $t_r = t_f = 20\text{ ns}$)

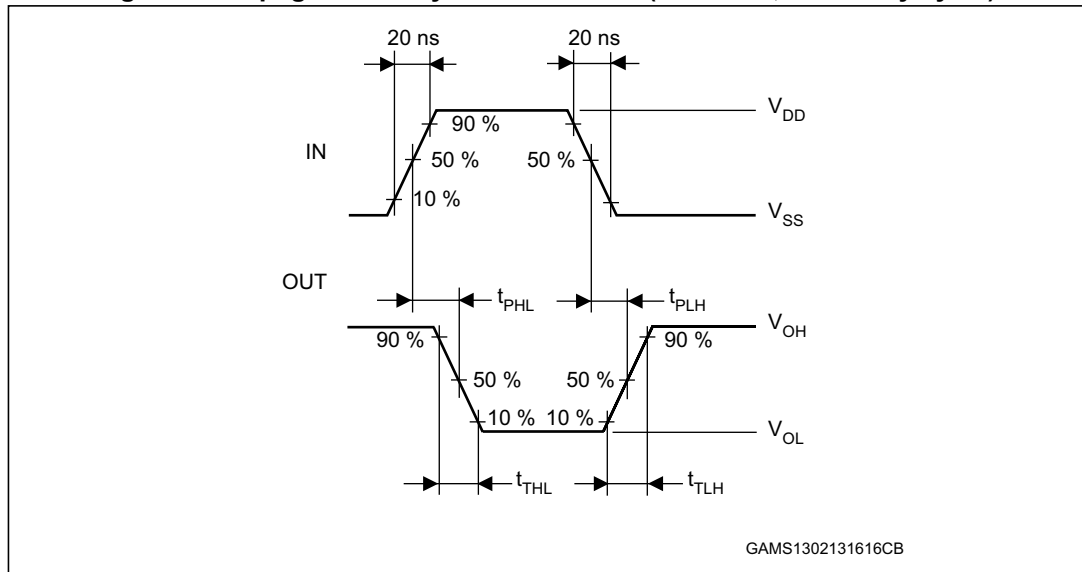
Symbol	Parameter	Test condition	Value ⁽¹⁾		Unit
		V_{DD} (V)	Typ.	Max.	
t_{PLH} , t_{PHL}	Propagation delay time	5	140	280	ns
		10	70	140	
		15	60	120	
t_{TLH} , t_{THL}	Output transition time	5	100	200	
		10	50	100	
		15	40	80	

1. The typical temperature coefficient for all V_{DD} values is 0.3 %/ $^{\circ}\text{C}$.

Figure 5. Test circuit

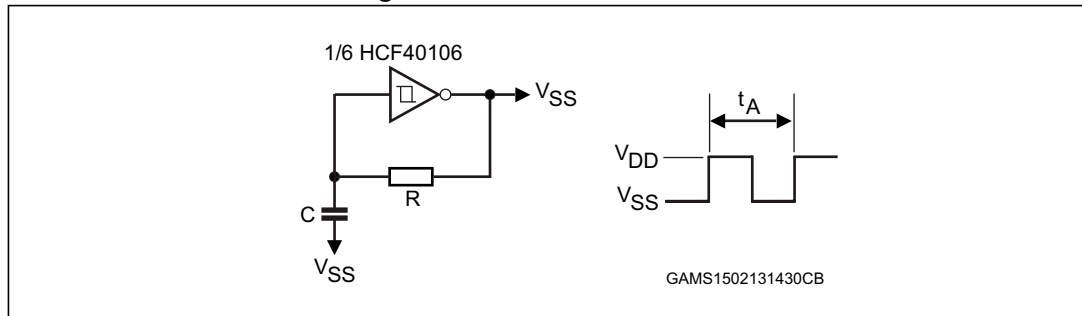


1. Legend: $C_L = 50\text{ pF}$ or equivalent (includes jig and probe capacitance), $R_L = 200\text{ k}\Omega$, $R_T = Z_{OUT}$ of pulse generator (typically $50\text{ }\Omega$)

Figure 6. Propagation delay time waveform ($f = 1\text{ MHz}$; 50 % duty cycle)

4 Typical applications

Figure 7. Astable multivibrator



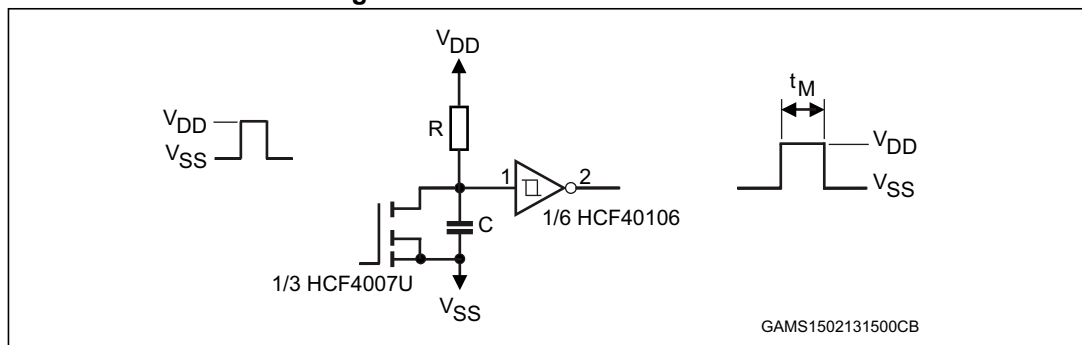
$$t_A = RC \ln \left[\left(\frac{V_P}{V_N} \right) \left(\frac{V_{DD} - V_N}{V_{DD} - V_P} \right) \right]$$

$$50 \text{ k}\Omega \leq R \leq 1 \text{ M}\Omega$$

$$100 \text{ pF} \leq C \leq 1 \text{ }\mu\text{F}$$

For the range of R and C given $2 \text{ }\mu\text{s} < t_A < 0.4 \text{ s}$

Figure 8. Monostable multivibrator

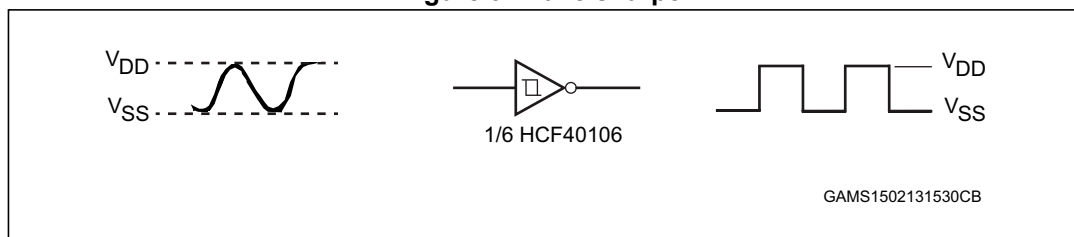


$$t_M = RC \ln \left(\frac{V_{DD}}{V_{DD} - V_P} \right)$$

$$50 \text{ k}\Omega \leq R \leq 1 \text{ M}\Omega$$

$$100 \text{ pF} \leq C \leq 1 \text{ }\mu\text{F}$$

For the range of R and C given $5 \text{ }\mu\text{s} < t_M < 1 \text{ s}$

Figure 9. Wave shaper

The frequency range of the wave shape is from DC to 1 MHz.

5 Package information

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Figure 10. SO-14 package mechanical drawing

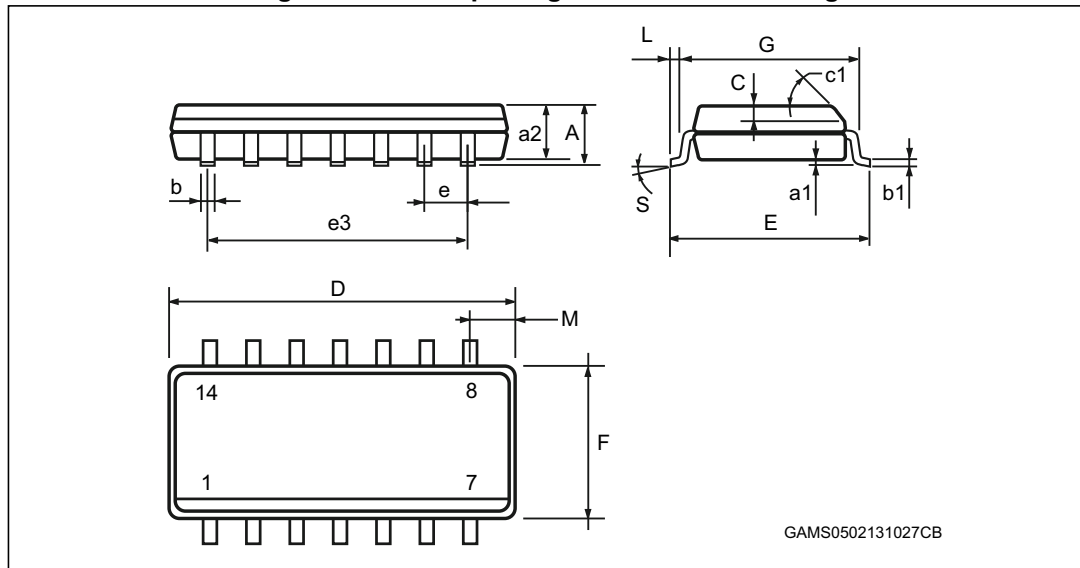
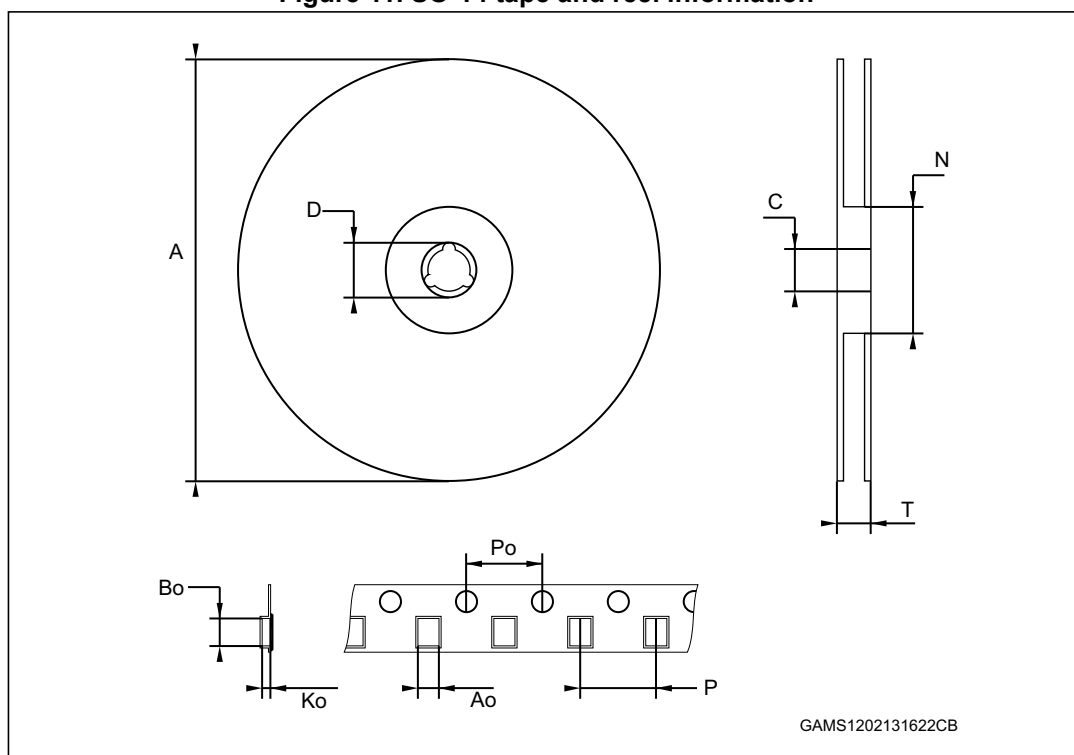


Table 8. SO-14 package mechanical data

Ref	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.75			0.068
a1	0.1		0.2	0.003		0.007
a2			1.65			0.064
b	0.35		0.46	0.013		0.018
b1	0.19		0.25	0.007		0.010
C		0.5			0.019	
c1		45 °			45 °	
D	8.55		8.75	0.336		0.344
E	5.8		6.2	0.228		0.244
e		1.27			0.050	
e3		7.62			0.300	
F	3.8		4.0	0.149		0.157
G	4.6		5.3	0.181		0.208
L	0.5		1.27	0.019		0.050
M			0.68			0.026
S			8 °			8 °

Figure 11. SO-14 tape and reel information



1. Drawing is not to scale.

Table 9. SO-14 tape and reel information

Ref	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			330			12.992
C	12.8		13.2	0.504		0.519
D	20.2			0.795		
N	60			2.362		
T			22.4			0.882
Ao	6.4		6.6	0.252		0.260
Bo	9		9.2	0.354		0.362
Ko	2.1		2.3	0.082		0.090
Po	3.9		4.1	0.153		0.161
P	7.9		8.1	0.311		0.319

6 Ordering information

Table 10. Order codes

Order code	Temperature range	Package	Packing	Marking
HCF40106M013TR	-55 ° C to +125 ° C	SO-14	Tape & reel	HCF40106
HCF40106YM013TR ⁽¹⁾	-40 ° C to +125 ° C	SO-14 (automotive grade) ⁽¹⁾		HCF40106Y

1. Qualification and characterization according to AEC Q100 and Q003 or equivalent, advanced screening according to AEC Q001 and Q002 or equivalent.

7 Revision history

Table 11. Document revision history

Date	Revision	Changes
19-Feb-2013	3	Document template and layout updated Updated package names (PDIP-14 and SO-14 instead of DIP-14 and SOP-14) Updated Features Added Applications Updated Device summary table Removed "HCC" from Figure 7 , Figure 8 , and Figure 9 Added Section 6: Ordering information
06-Jan-2014	4	Removed DIP package option Added ESD performance to Features Updated footnote 1 of Table 1: Device summary table Updated footnote 1 of Table 10: Order codes

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